MC3420
MC3520

MOTOROLA

Specifications and Applications Information

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SWITCHMODE REGULATOR CONTROL CIRCUIT

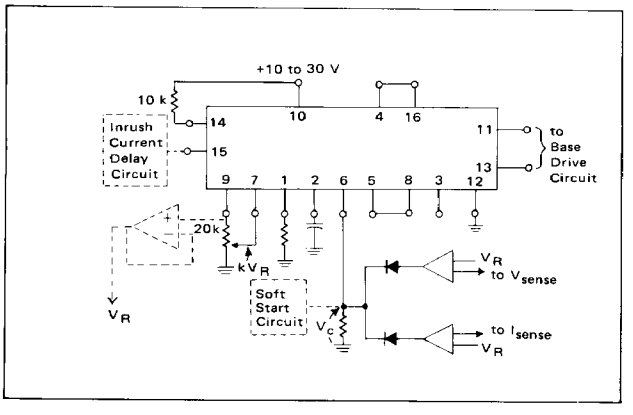
The MC3520/3420 is an inverter control unit which provides all the control circuitry for PWM push-pull, bridge and series type switchmode power supplies.

These devices are designed to supply the pulse width modulated drive to the bases of two external power transistors. Other applications where these devices can be used are in transformerless voltage doublers, transformer coupled dc-to-dc converters and other power control functions.

The MC3520 is specified over the military operating range of −55°C to +125°C. The MC3420 is specified from 0°C to +70°C.

- Includes Symmetrical Oscillator
- On Chip Pulse Width Modulator, Voltage Reference, Dead Time Comparator, and Phase Splitter
- Output Frequency Adjustable (2.0 kHz to 100 kHz)
- Inhibit and Symmetry Correction Inputs Available
- Controlled Start-Up
- Frequency and Dead Time are Independently Adjustable (0% to 100%)
- Can be Slaved to Other MC3420s
- Open Collector Outputs
- Output Capability 50 mA (Max.)
- On Chip Protection Against Double Pulsing of Same Output During Load Transient Condition

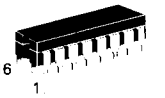
FIGURE 1–TYPICAL APPLICATION



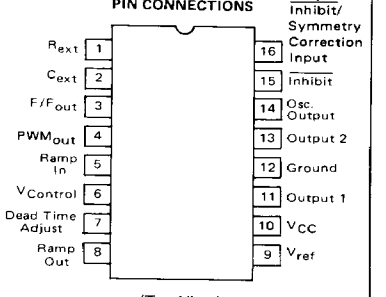
SWITCHMODE REGULATOR CONTROL CIRCUIT

SILICON MONOLITHIC INTEGRATED CIRCUITS

P SUFFIX
PLASTIC PACKAGE
CASE 648-05
(MC3420 only)



L SUFFIX
CERAMIC PACKAGE
CASE 620-02



(Top View)

ORDERING INFORMATION

DEVICE	TEMPERATURE RANGE	PACKAGE
MC3420P	0 to +70°C	Plastic DIP
MC3420L	0 to +70°C	Ceramic DIP
MC3520L	-55 to +125°C	Ceramic DIP

MAXIMUM RATINGS

Rating	Symbol	MC3520	MC3420	Unit
Power Supply Voltage	V_{CC}	30		V
Output Voltage (pins 11 and 13)	V_{out}	40		V
Oscillator Output Voltage (pin 14)	V_{14}	30		V
Voltage at pin 4	V_4	2.0		V
Voltage at pins 3 and 8	V_3, V_8	5.0		V
Voltage at pin 5	V_5	7.0		V
Power Dissipation	P_D	See Thermal Information		
Operating Junction Temperature Plastic Package Ceramic Package	T_J	 – 150	 125 150	°C
Operating Ambient Temperature Range	T_A	-55 to +125	0 to +70	°C
Storage Temperature Range	T_{stg}	-65 to +150	-65 to +150	°C

ELECTRICAL CHARACTERISTICS (V_{CC} = 10 to 30 V, T_A = 25°C unless otherwise noted.)

Characteristic	Figure	Symbol	MC3520 Min	MC3520 Typ	MC3520 Max	MC3420 Min	MC3420 Typ	MC3420 Max	Unit
REFERENCE SECTION									
Reference Voltage (I_{ref} = 400 μA)	5	V_{ref}	7.6	7.8	8.0	7.4	7.8	8.2	V
Temperature Coefficient of Reference Voltage (V_{CC} = 15 V, I_{ref} = 400 μA)	5	TCV_{ref}	–	0.008	0.03	–	0.008	0.03	%/°C
Input Regulation of Reference Voltage (I_{ref} = 400 μA) (I_{ref} = 1.0 mA)	5	Reg_{line}	 – –	 3.0 5.0	 7.5 –	 – –	 4.0 5.0	 7.5 –	mV/V
DC SUPPLY SECTION									
Supply Voltage	5	V_{in}	10	–	30	10	–	30	V
Supply Current (R_{ext} = 10 kΩ, excluding load and current and reference current)	5	I_D	–	–	16	–	–	22	mA
OSCILLATOR SECTION									
Line Frequency Stability (f = 20 kHz) (f = 20 kHz, V_{CC} = 15 V, T_{low} to T_{high})	5	 Δf Δf	 – –	 – 0.03	 3.0 –	 – –	 – 0.04	 5.0 –	% %/°C
Maximum Output Frequency (V_{CC} = 15 V)	6	f_{max}	100	200	–	100	200	–	kHz
Minimum Output Frequency (V_{CC} = 15 V)	6	f_{min}	–	2.0	5.0	–	2.0	5.0	kHz
Oscillator Output Saturation Voltage ($I_{14\ sink}$ = 5.0 mA)	11	$V_{osc(sat)}$	–	0.2	0.5	–	0.2	0.5	V
OUTPUT SECTION									
Output Saturation Voltage (I_L = 40 mA, T_{high} to T_{low}) (I_L = 25 mA, T_{high} to T_{low})	7	$V_{CE(sat)}$	 – –	 0.33 0.22	 0.5 –	 – –	 0.33 0.22	 0.5 –	V
Output Leakage Current (V_{CE} = 40 V, Pins 11 and 13)	8	I_{CE}	–	–	50	–	–	50	μA
COMPARATOR SECTION									
Pulse Width Adjustment Range	9	ΔPW	0	–	100	0	–	100	%
Dead Time Adjustment Range	9	ΔDT	0	–	100	0	–	100	%
Temperature Coefficient of Dead Time	–	TCDT	–	0.1	–	–	0.1	–	%/°C
Comparator Bias Currents	12, 13 14	I_{IB} I_{IB}	– –	5.0 10	15 30	– –	5.0 10	15 30	μA μA

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ELECTRICAL CHARACTERISTICS (continued)

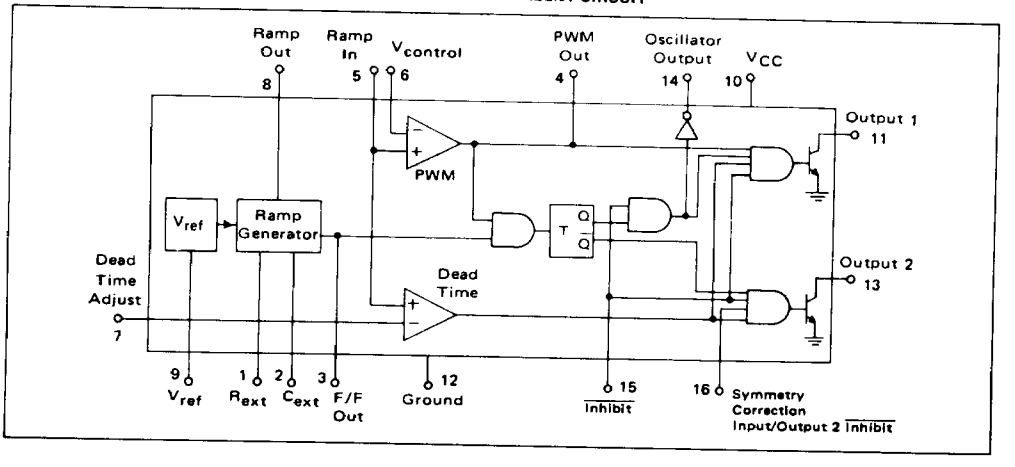
Characteristic	Figure	Symbol	MC3520 Min	MC3520 Typ	MC3520 Max	MC3420 Min	MC3420 Typ	MC3420 Max	Unit
AUXILIARY INPUTS/OUTPUTS									
Ramp Voltage Peak High Peak Low	5	 $V_{ramp(Hi)}$ $V_{ramp(Low)}$	 5.5 2.0	 6.0 2.4	 6.5 2.8	 5.5 2.0	 6.0 2.4	 6.5 2.8	V
Ramp Voltage Change ($V_{ramp\ Hi} - V_{ramp\ Low}$)	5	ΔV_{ramp}	3.0	3.5	4.0	3.0	3.5	4.0	V
Ramp Out Sink Current	5	I_{sink}	–	400	–	–	400	–	μA
Ramp Out Source Current	5	I_{source}	–	3.0	–	–	3.0	–	mA
$\overline{\text{Inhibit}}$ Input Current – High (V_{IH} = 2.0 V)	10	I_{IH}	–	–	40	–	–	40	μA
$\overline{\text{Inhibit}}$ Input Current – Low (V_{IL} = 0.8 V)	10	I_{IL}	–	–25	–180	–	–25	–180	μA
Symmetry Correction Input/Output 2 Inhibit Current – High (V_{SY} = 2.0 V, Pin 16)	10	$I_{SY/H}$	–	–	40	–	–	40	μA
Symmetry Correction Input/Output 2 Inhibit Current – Low (V_{SY} = 0.8 V, Pin 16)	10	$I_{SY/L}$	–	–10	–180	–	–10	–180	μA
F/F_{out} Source Current	–	I_{source}	–	2.0	–	–	2.0	–	mA
OUTPUT AC CHARACTERISTICS ($T_A = T_{high}$, V_{CC} = +15 V, f = 20 kHz)									
Rise Time	15	t_r	–	40	–	–	40	–	ns
Fall Time	15	t_f	–	150	–	–	150	–	ns
Overlap Time	15	t_{ov}	–	275	–	–	275	–	ns
Assymmetry (Duty Cycle = 50%)	15	$\frac{t_{on1} - t_{on2}}{t_{on1}}$	–	±1.0	–	–	±1.0	–	%

NOTE:

T_{high} = +125°C for MC3520
+70°C for MC3420

T_{low} = -55°C for MC3520
0°C for MC3420

FIGURE 2–EQUIVALENT CIRCUIT



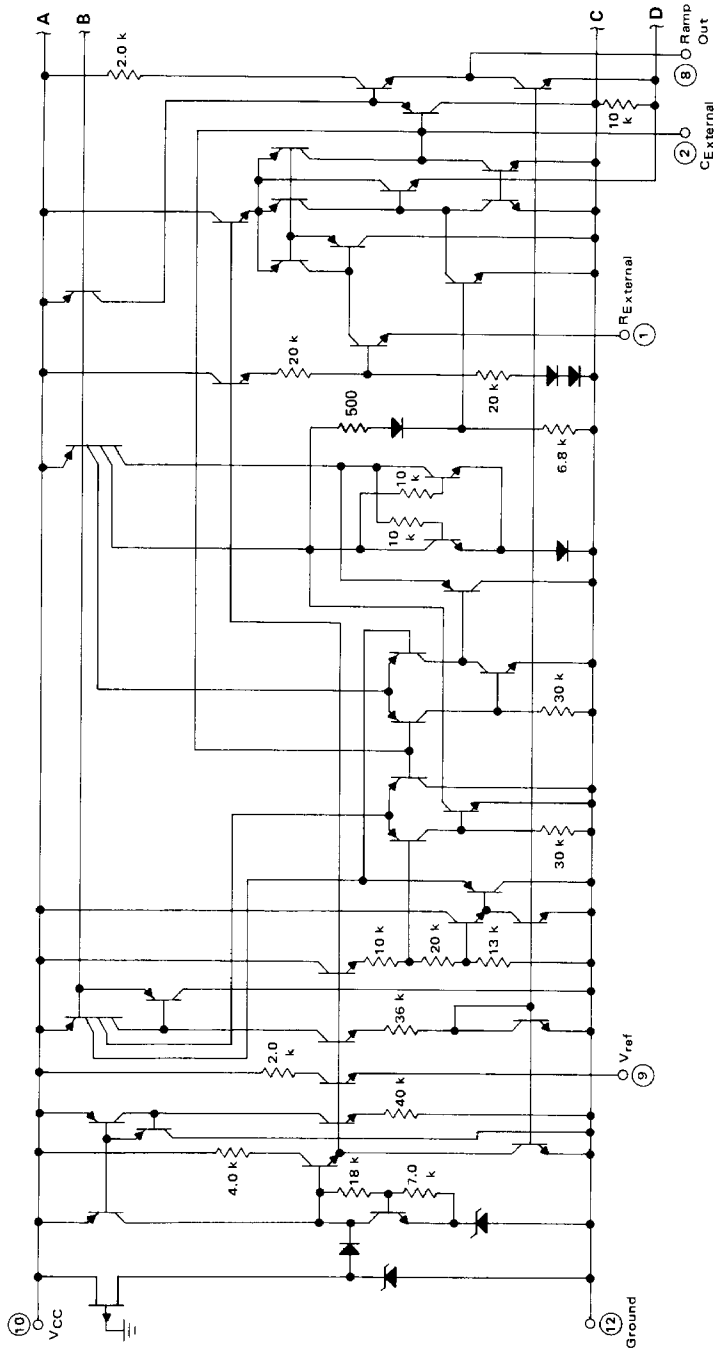


FIGURE 3 – CIRCUIT SCHEMATIC
(continued next page)

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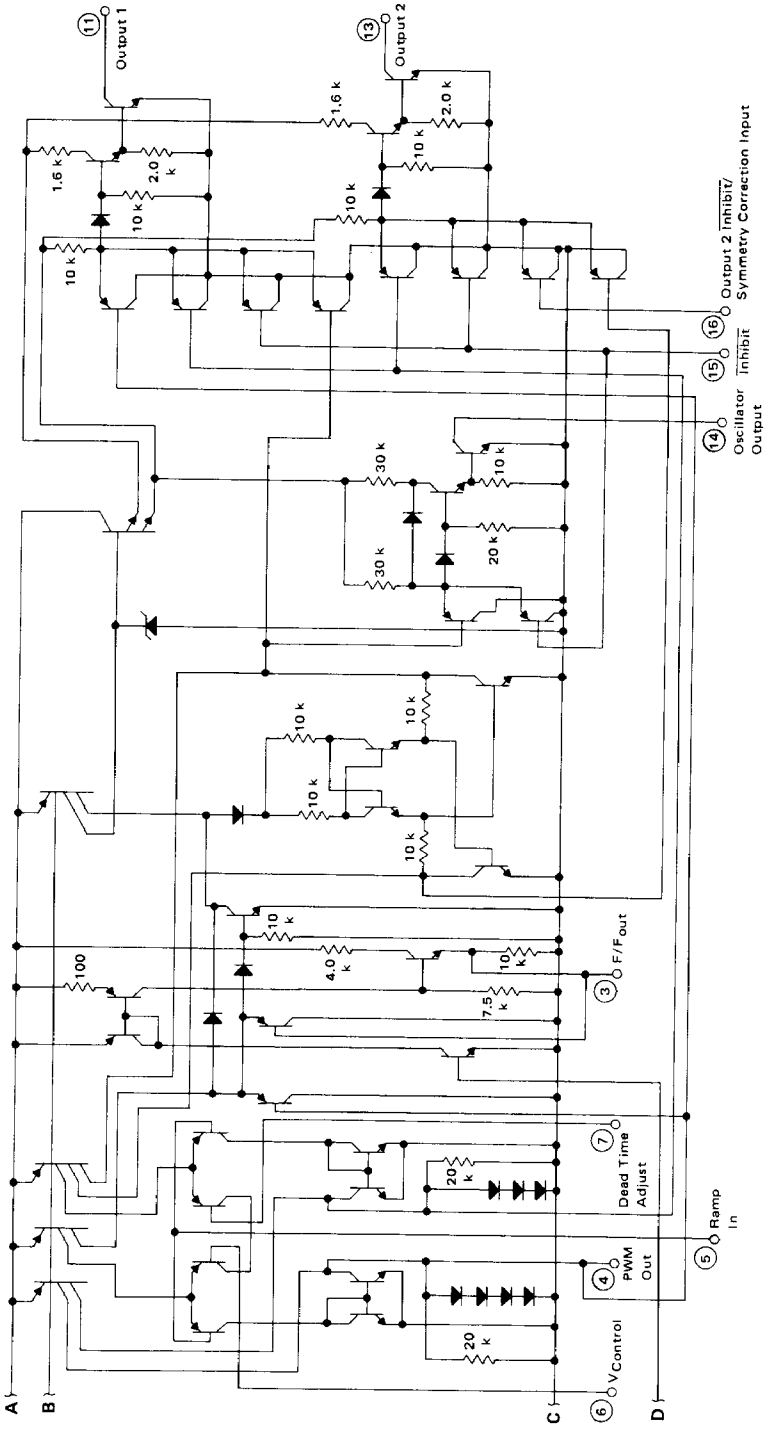
(continued) FIGURE 3 – CIRCUIT SCHEMATIC



GENERAL INFORMATION

The internal block diagram of the MC3420 is shown in Figure 2, and consists of the following sections:

Voltage Reference

A stable reference voltage is generated by the MC3420 primarily for internal use. However, it is also available externally at Pin 9 (V_{ref}) for use in setting the dead time (Pin 7) and for use as a reference for the external control loop error amplifiers.

Ramp Generator

The ramp generator section produces a symmetrical triangular waveform ramping between 2.4 V and 6.0 V, with frequency determined by an external resistor (R_{ext}) and capacitor (C_{ext}) tied from Pins 1 and 2, respectively, to ground.

PWM Comparator

The output of the ramp generator at pin 8 is normally connected to Pin 5, RAMP IN. The PWM (pulse width modulation) comparator compares the voltage at Pin 6 ($V_{control}$) to the ramp generator output. The level of $V_{control}$ determines the outputs' pulse width or duty cycle. The duty cycle of each output can vary, exclusive of dead time, from 50% (when $V_{control}$ is at approximately 2.4 V) to 0% ($V_{control}$ approximately 6.0 V).

Dead Time Comparator

An additional comparator has been included in MC3420 to allow independent adjustment of system dead time or maximum duty cycle. By dividing down V_{ref} at Pin 9 with a resistive divider or potentiometer, and applying this voltage to Pin 7, a stable dead time is obtained for prevention of inverter switching transistor cross conduction at high duty cycles due to storage time delays.

Phase Splitter

A phase splitter is included to obtain two 180° out of phase outputs for use in multiple transistor inverter systems. It consists of a toggle flip-flop whose clock signal is derived by "ANDing" the output of the PWM comparator and a signal from the ramp generator section. This "AND" gate ensures that the outputs truly alternate under control loop transient conditions. Better understanding of this feature and MC3420 operation may be gained by studying the circuit waveforms, shown in Figure 4.

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FIGURE 4 – INTERNAL WAVEFORMS

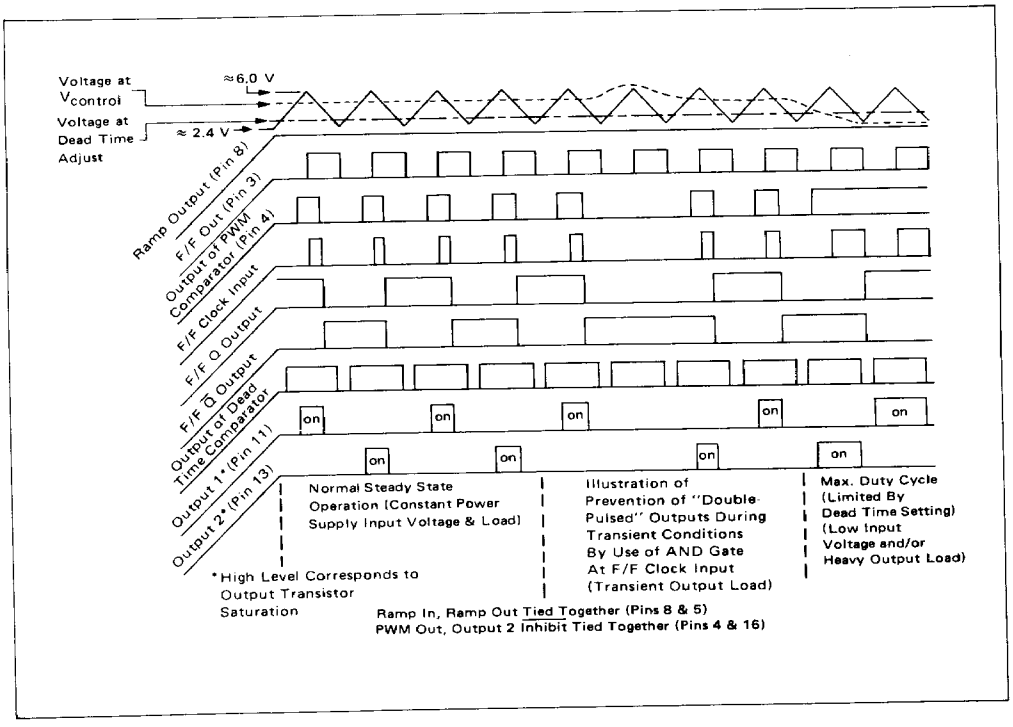

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FIGURE 5 – STANDARD AC, DC TEST CIRCUIT

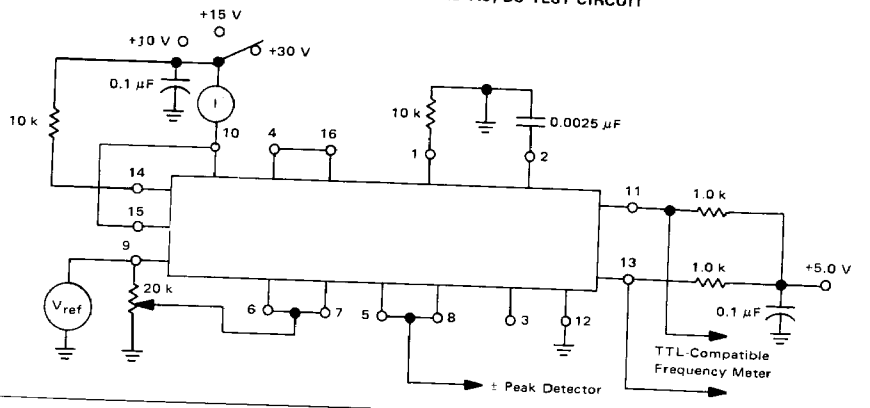


FIGURE 6 – FREQUENCY LIMIT TEST CIRCUIT

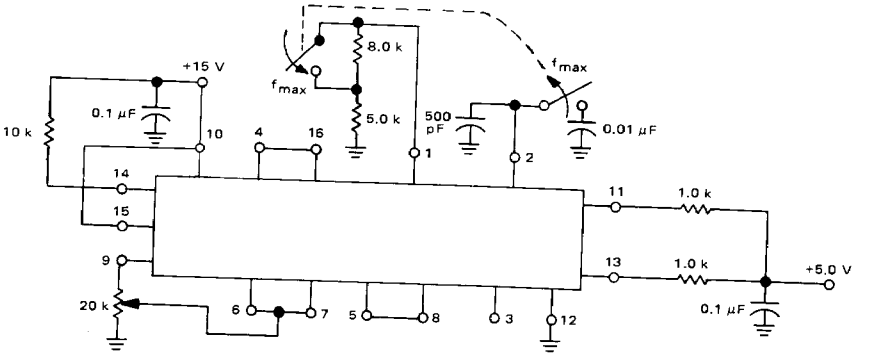
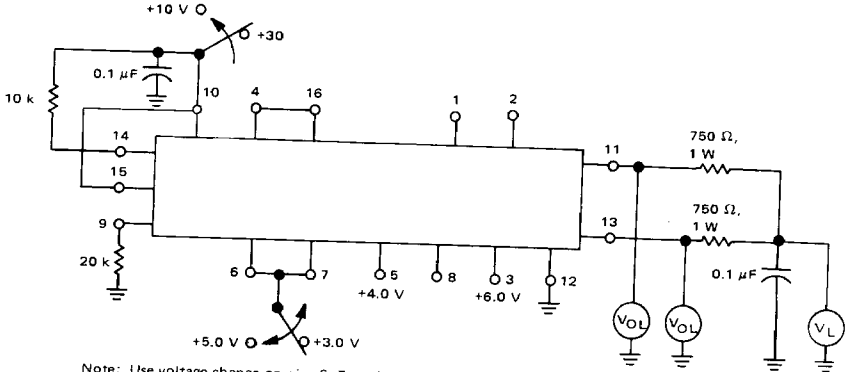
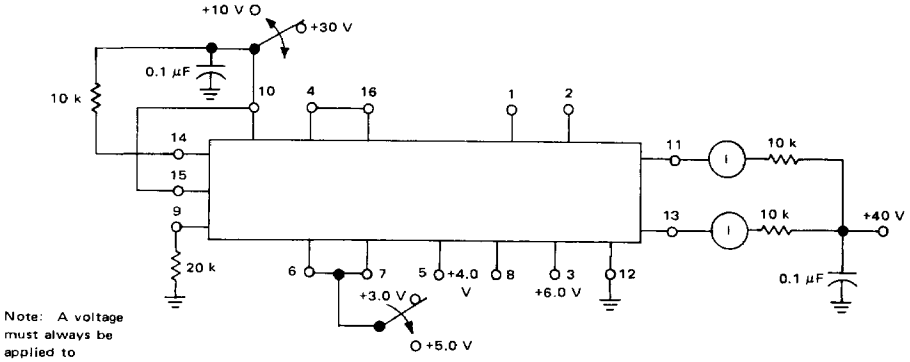


FIGURE 7 – OUTPUT SATURATION TEST CIRCUIT



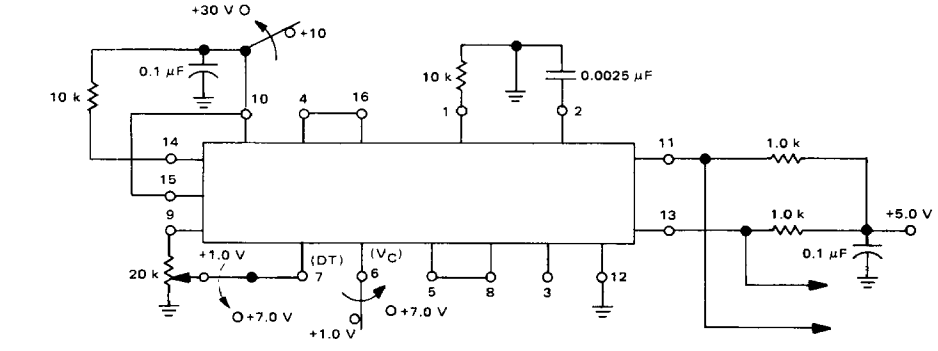
Note: Use voltage change on pins 6, 7 to change output states.
A voltage must always be present on pins 6 and 7.

FIGURE 8 – OUTPUT LEAKAGE TEST CIRCUIT



Note: A voltage must always be applied to pins 6 and 7.

FIGURE 9 – OUTPUT DUTY CYCLE TEST CIRCUIT



TYPICAL DUTY CYCLE versus DEAD TIME VOLTAGE		TYPICAL DUTY CYCLE versus PWM VOLTAGE ($V_{control}$)	
PIN 7. DEAD TIME VOLTAGE (V) ($V_{control}$ = 2.0 V)	% DUTY CYCLE (FOR EACH OUTPUT)	PIN 6. $V_{control}$ (V) (DEAD TIME VOLTAGE = 1.0 V)	% DUTY CYCLE (FOR EACH OUTPUT)
2.0	50	2.0	50
2.5	46	2.5	46
3.0	40	3.0	40
3.5	33	3.5	33
4.0	26	4.0	26
4.5	18	4.5	18
5.0	11	5.0	11
5.5	4.0	5.5	4.0
6.0	0	6.0	0

	V_6	V_7	
	Volts		
100% Adjust			
Dead Time	1.0	1.0	(Pin 11 + Pin 13 = Logic "1")
Pulse Width	1.0	1.0	
0% Adjust			
Dead Time	7.0	1.0	(Pin 11)(Pin 13) = Logic "1"
Pulse Width	1.0	7.0	

NOTE: Logic "1" is TTL-Compatible V_{OH}.

FIGURE 10 – INHIBIT/SYMMETRY TEST CIRCUIT

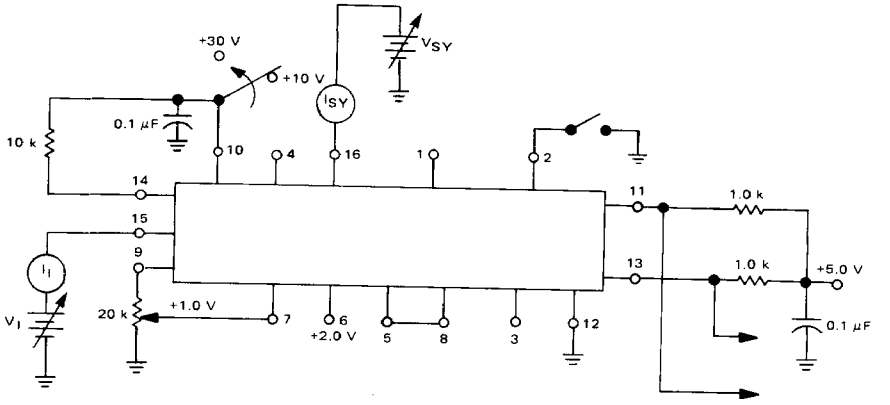


FIGURE 11 – OSCILLATOR OUTPUT (pin 14) TEST CIRCUIT

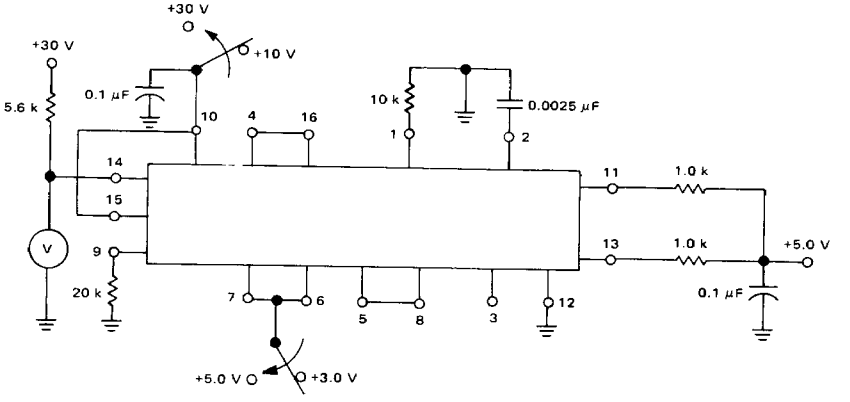


FIGURE 12 – $V_{Control}$ BIAS CURRENT TEST CIRCUIT

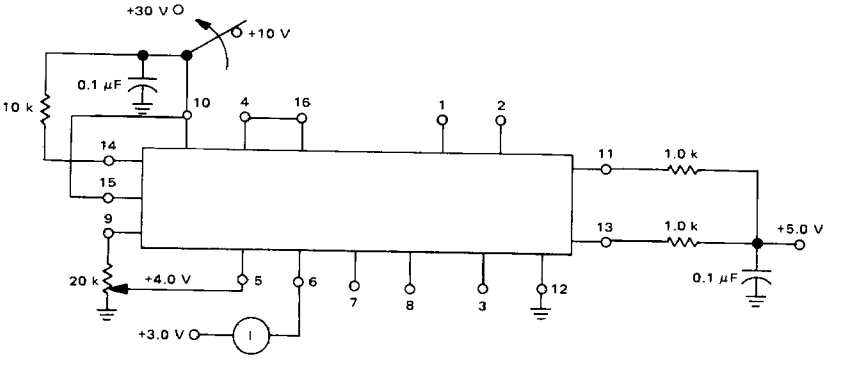


FIGURE 13 – DEAD TIME BIAS CURRENT TEST CIRCUIT

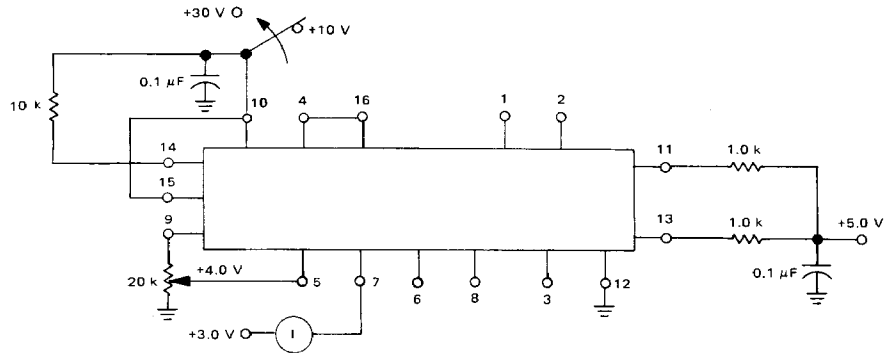


FIGURE 14 – RAMP IN BIAS CURRENT TEST CIRCUIT

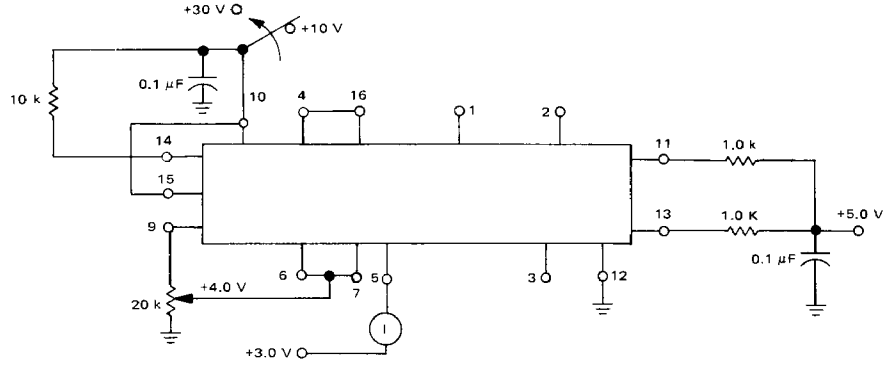
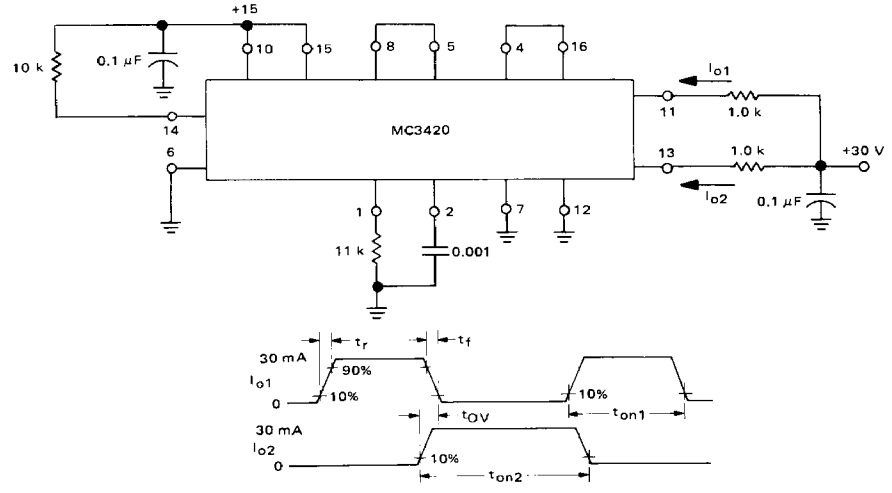


FIGURE 15 – AC TEST CIRCUIT AND WAVEFORMS



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TYPICAL CHARACTERISTICS

FIGURE 16 – OUTPUT SATURATION VOLTAGE versus LOAD CURRENT

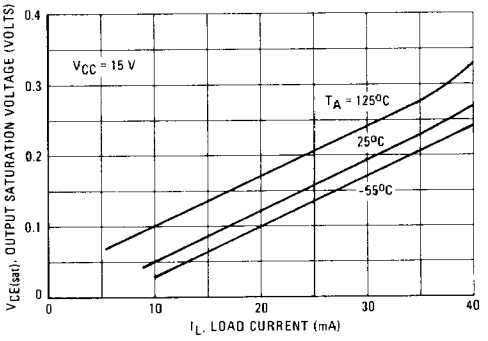


FIGURE 17 – REFERENCE VOLTAGE versus REFERENCE CURRENT

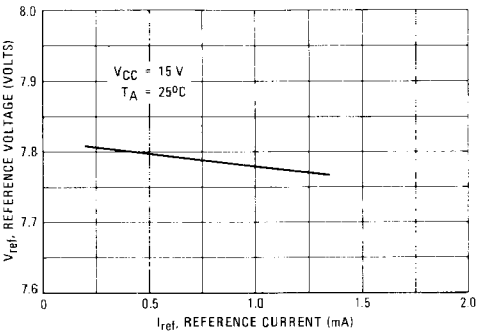


FIGURE 18 – DRAIN CURRENT versus EXTERNAL RESISTANCE

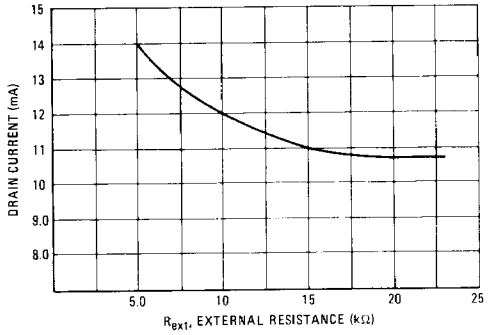


FIGURE 19 – PEAK FLIP-FLOP$_{out}$ VOLTAGE versus EXTERNAL RESISTANCE

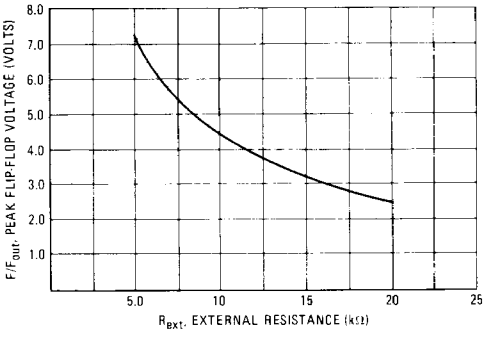


FIGURE 20 – DRAIN CURRENT versus TEMPERATURE

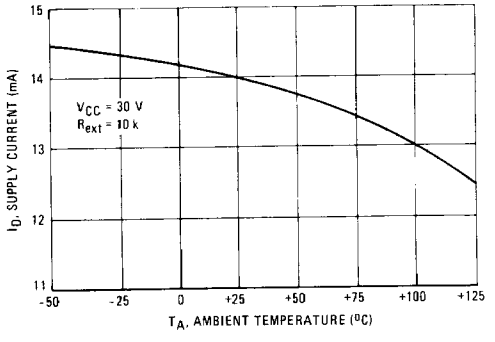
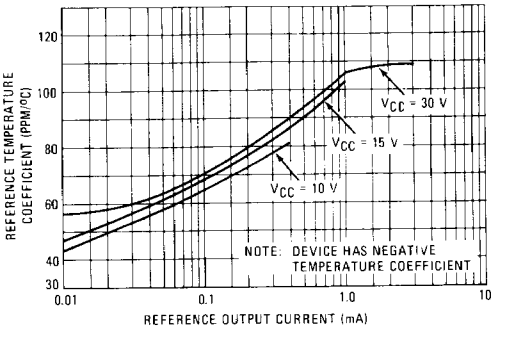


FIGURE 21 – REFERENCE VOLTAGE TEMPERATURE COEFFICIENT versus OUTPUT CURRENT

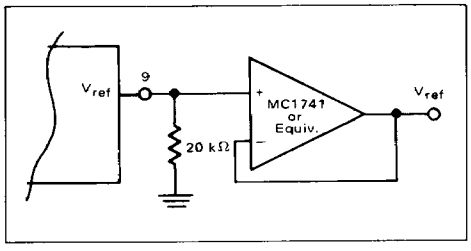


OPERATION AND APPLICATIONS INFORMATION

The Voltage Reference

The temperature coefficient of V_{ref} has been optimized for a 400 μA (≅20 kΩ) load. If increased current capability is required, an op amp buffer may be used, as shown in Figure 22.

FIGURE 22



Output Frequency

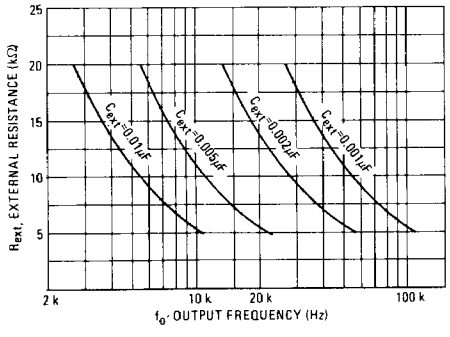
The values of R_{ext} and C_{ext} for a given output frequency, f_o, can be found from:

$$f_o \cong \frac{0.55}{R_{ext}\,C_{ext}} \; ; 5.0\ k\Omega \leq R_{ext} \leq 20\ k\Omega \quad \text{(Eq. 1)}$$

or from the graph shown in Figure 23.

Note that f_o refers to the frequency of Output 1 (Pin 11) or Output 2 (Pin 13). The frequency of the ramp generator output waveform at Pin 8 will be twice f_o.

FIGURE 23

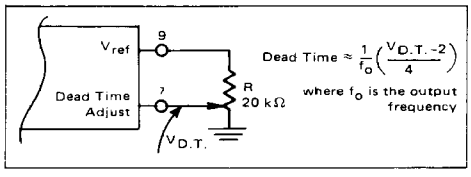


Dead Time

Figure 24 illustrates how to set or adjust the MC3420 outputs' dead time or maximum duty cycle. For minimum dead time drift with temperature or supply voltage, $V_{D.T.}$ should be derived from V_{ref} as shown.

Pin 7 should always be tied to some voltage between Gnd and V_{ref}.

FIGURE 24



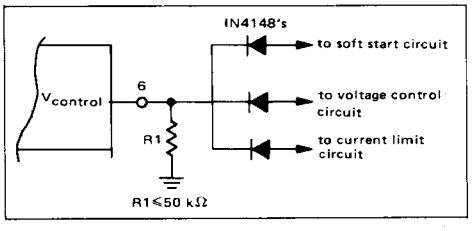
Connections to the $V_{control}$ Pin

In many systems, it is necessary to make multiple connections to the $V_{control}$ Pin in order to implement features in addition to voltage regulation such as current limiting, soft start, etc. These can be made by the use of a simple "diode-OR" connection, as shown in Figure 25. This allows whichever control element is seeking the lowest PWM duty cycle to dominate. Note that a resistor, R1, whose value is ≤ 50 kΩ is placed from the $V_{control}$ Pin to ground. This is necessary to provide a dc path for the PWM comparator input bias current under all conditions.

The system duty cycle is given by:

$$\text{D.C. (\%)} \cong \frac{V_{Control} - 2}{4} \times 100 \quad \text{(Eq. 2)}$$

FIGURE 25



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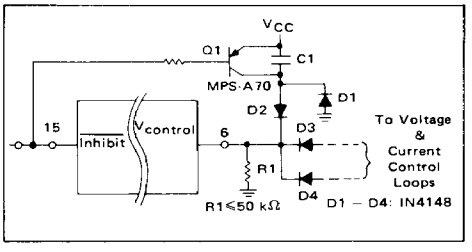
Soft Start

In most PWM switching supplies, a soft start feature is desired to prevent output voltage overshoots and magnetizing current imbalances in the power transformer primary. This feature forces the duty cycle of the switching elements to gradually increase from zero to their normal operating point during initial system power-up or after an inhibit. This feature can be easily implemented with the MC3420. One method is shown in Figure 26.

FIGURE 26



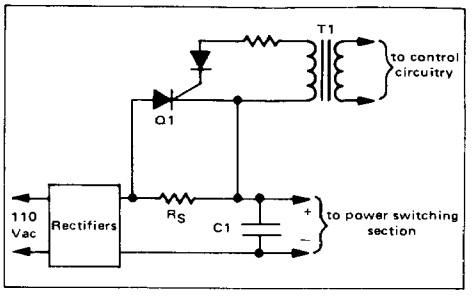
After an inhibit command or during power-up, the voltage on R1 and Pin 6 exponentially decays from V_{CC} toward ground with a time constant of R1C1, allowing a gradual increase in duty cycle. Diodes D2 – D4 provide a diode-or function at the $V_{control}$ Pin, while Q1 serves to reset the timing capacitor, C1, when an inhibit command is received thereby reinitializing the soft-start feature. D1 allows C1 to reset when power (V_{CC}) is turned off.

Inrush Current Limiting

Since many PWM switching supplies are operated directly off the rectified 110 Vac line with capacitive input filters, some means of preventing rectifier failure due to inrush surge currents is usually necessary. One method which can be used is shown in Figure 27.

In this circuit, a series resistor, R_S, is used to provide inrush surge current limiting. After the filter capacitor, C1, is charged, Q1 receives a trigger signal from the control circuitry through T1 and shorts R_S out of the circuit, eliminating its otherwise larger power dissipation. The trigger signal for Q1 may be derived from either the oscillator output (Pin 14) or one of the MC3420's outputs. If the oscillator output is used, it will be necessary

FIGURE 27

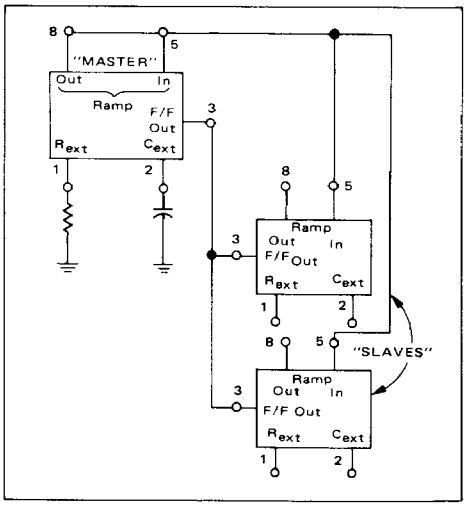


to provide a time delay on the inhibit pin to keep it low until the input filter capacitor, C1, has had time to charge, whereas the initial portion of the soft start timing cycle can be used for this delay if this signal is derived from one of the output pins. However, using the Oscillator Output Pin does offer the advantage that its waveform has a constant 50% duty cycle, independent of the outputs' duty cycle which can simplify the design of a drive circuit for T1.

Slaving

In some applications, as when one PWM inverter/converter is used to feed another, it may be desired that their frequencies be synchronized. This can be done with multiple MC3420s as shown in Figure 28. By omitting their R_{ext} and C_{ext}, up to two MC3420s may be slaved to a master MC3420.

FIGURE 28 – SLAVING THE MC3420



15 V, 2 A DC-to-DC Converter

Figure 29 illustrates the use of the MC3520 in a PWM switching power supply utilizing a single series switching element (see Appendix for description of PWM switching supply configurations). The series switching transistor, Q1, chops the dc input voltage, V_{in}, at a frequency of ≅ 25 kHz, and the resulting waveform is filtered by L1 and C1 to provide the dc output voltage. The frequency is set by R4 and C3, and since the outputs of the MC3520 are wire-ORed together, fo is twice that given by Equation 1 and Figure 23. V_o is regulated by comparing its value to the MC3520's reference voltage and amplifying the error voltage with U1. The output of U1 is fed into the MC3520 to provide PWM to Q1, thereby controlling its duty cycle and thus the value of V_o.

C2 provides a soft-start feature during power up to prevent output voltage overshoots and excessive start up currents through Q1.

Short circuit protection is provided by R_{SC}, Q3 and Q4. When an overcurrent condition occurs, Q3 is turned on by the voltage across R_{SC}; Q3 drives Q4 on, which raises the voltage at pin 6 ($V_{control}$) of the MC3520, reducing Q1's duty cycle and maintaining a constant output current of ≅ 2.5 A.

5 V, 50 A Line-Operated Supply

A 5 V, 50 A line-operated 20 kHz switching power supply using the MC3520 is shown in Figures 30a and b. An explanation of the operation of each section of the supply follows.

Input Section

The 120 Vac line is full wave voltage doubled by CR1, CR2, C1 and C2 to provide 310 Vdc to the power section of the supply. Inrush surge current limiting is provided by R1, which is shorted out of the circuit by Q1 after C1 and C2 are initially charged.

Power Section

The supply utilizes two switching transistors, Q2 and Q3, in a half-bridge configuration (see Appendix) to drive the high frequency power transformer, T2.

The bases of Q2 and Q3 are driven by T3 and T4, respectively, to provide isolation from the control and base drive sections of the supply. CR3, CR5, CR6, and CR8 constitute anti-saturation (Baker) clamps which provide increased and more uniform switching speeds for Q2 and Q3. CR4 and CR7 allow reverse base currents during turn off.

Output Section

The output of T2 is rectified by Schottky diodes, CR9 and CR10. VR1 is a transient suppressor to protect CR9 and CR10 from transients that might cause reverse breakdown. L1 and C4 constitute the output filter. C4 should have very low ESR (equivalent series resistance) at 20 kHz to provide the most effective filtering. L2 and C5 make up a high-frequency filter to reduce commutation spikes which pass L1 due to its interwinding capacitance. R_{SC} provides output overcurrent sensing to the control section.

Control Section

The MC3520 provides the PWM control for the supply. R2 is adjusted to obtain a 20 kHz operating frequency. R3 adjusts the dead time (≅ 5 μs each half-cycle). U1A and U1B are the output current and output voltage error amplifiers, respectively. R5 sets the output voltage while R4 determines the output current limit. C7 and C8 are the current and voltage loop compensation capacitors.

C6 provides the soft-start feature while Q4 ensures a soft-start after each system inhibit (pin 15 low).

Base Drive Section

Turn on drive to the power section switching transistors occurs when each of the outputs of the MC3520 saturate. Q5 or Q6 are therefore turned on, and 15 V applied to the primaries of T3 or T4, supplying forward base drive to Q2 or Q3.

Turn off drive occurs when Q5 or Q6 turn off, and the magnetizing energy stored in T3 or T4's core is transformed into a negative "flyback" voltage at their secondaries, providing reverse base drive to Q2 or Q3. CR11 and CR12 act as clamps, to prevent this flyback voltage from exceeding -5 V at T3 or T4's secondary (30 V on Q5 or Q6's collector).

Q1 Driver Section

Q7 and T1 provide the gate drive to Q1. Q7 starts operating after an initial delay of 100 ms created by the soft-start circuit, thereby allowing C1 and C2 to charge up before firing Q1.

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FIGURE 29 – 15 V, 2A DC-TO-DC CONVERTER

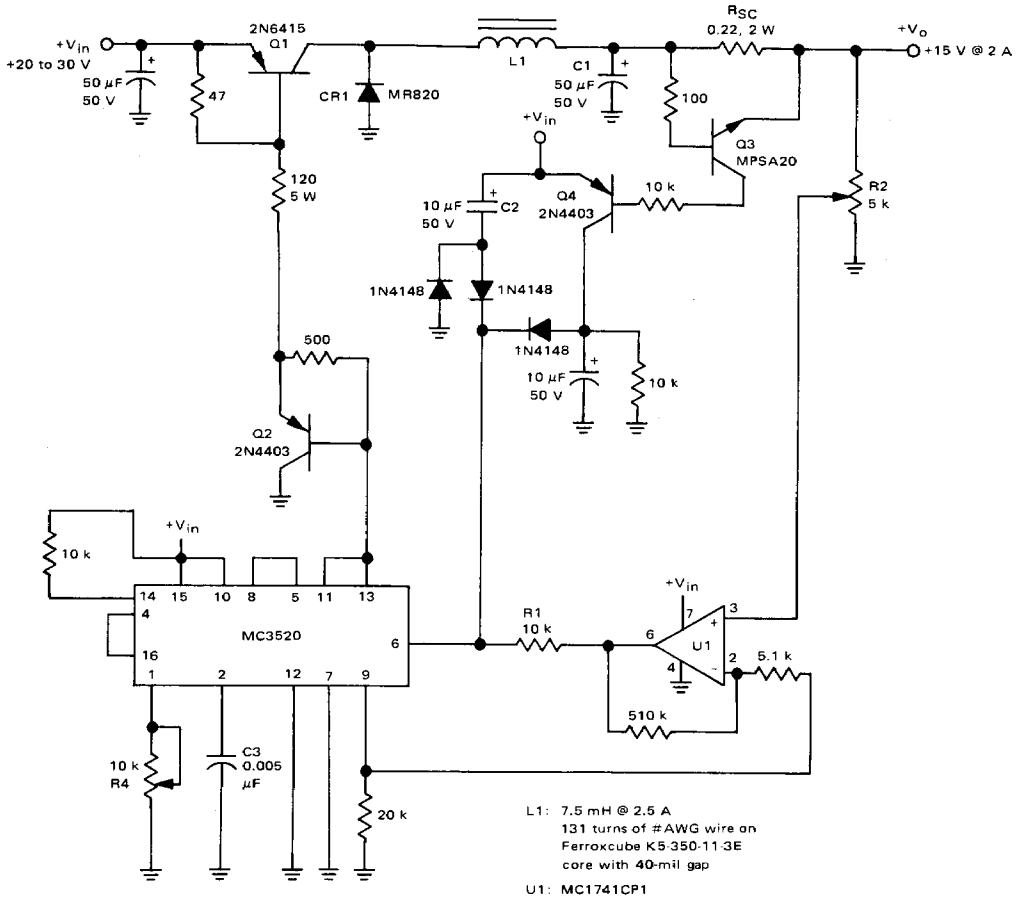
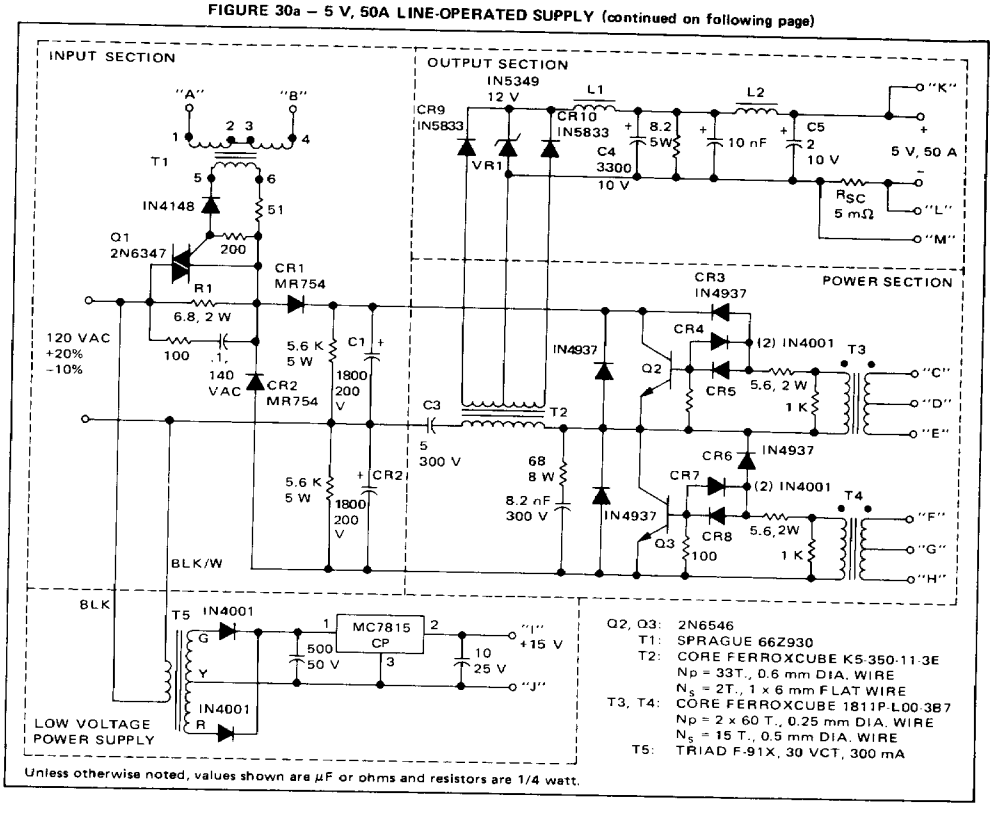
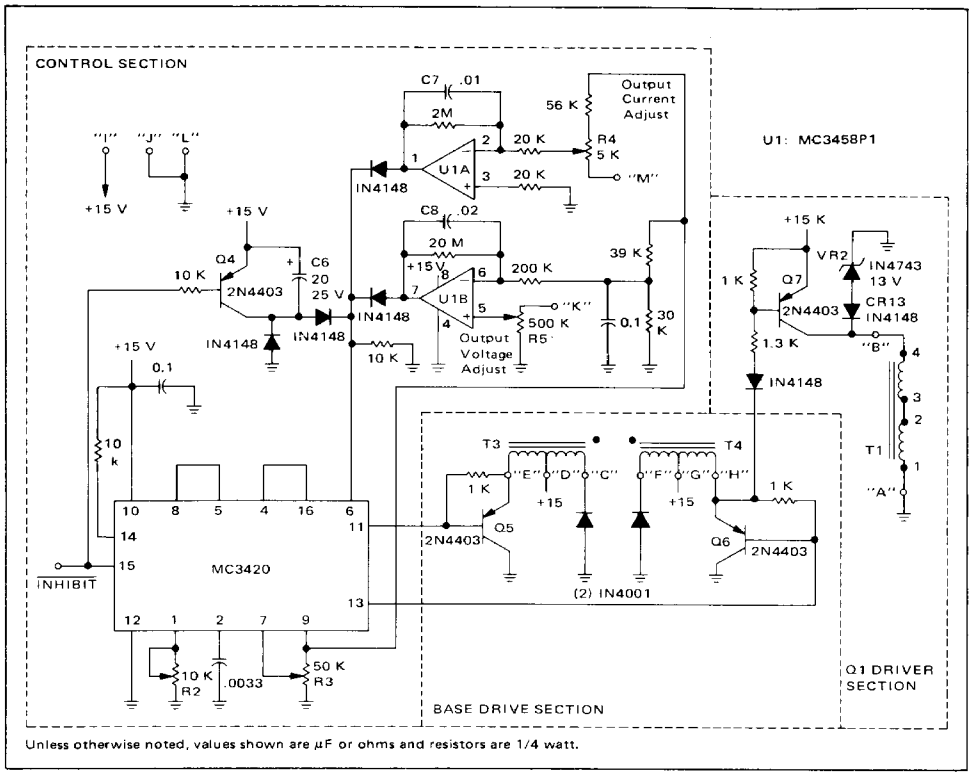


FIGURE 30a – 5 V, 50A LINE-OPERATED SUPPLY (continued on following page)



Performance	
Line Regulation:	0.4%
Load Regulation:	0.25%
Output Ripple and Noise:	60 mV p-p
	25 mV rms
Line current surge at turn-on:	35 A max
Efficiency:	80%

FIGURE 30b



APPENDIX: BASIC PWM SWITCHING SUPPLY POWER CIRCUIT CONFIGURATIONS

The material given in this section is intended to acquaint the designer with the basic switching transistor configurations used in PWM power supplies. Circuit configurations, collector voltage and current waveforms of the switching transistors, and required transistor specifications for the most commonly utilized configurations are shown in Figures 1A through 4A. It should be noted that the waveforms and specifications are idealized, in that the effects of leakage inductance voltage spikes, stray circuit capacitance, snubber networks, clamp diode overshoots, diode reverse recovery and saturation voltages have been neglected. For more information on these effects, the configurations, or switching supplies in general, consult the references listed in the References section.

Series Configuration

The single transistor series configuration is shown in Figure 1A. This configuration is usually limited to applications in which 0.2 $V_{CC} < V_o < 0.8\ V_{CC}$ and where input-output isolation is not required.

Push-Pull Configuration

Figure 2A shows the two-transistor push-pull configuration. Unlike the series configuration, it can be used to either step-up or step-down the input voltage, V_{CC}, and also provides input-output isolation. It does, however, have the disadvantage that additional circuitry must be used to provide symmetry correction for the prevention of transformer saturation.

Half-Bridge Configuration

The half-bridge configuration, shown in Figure 3A, does not suffer from the symmetry problems of the push-pull configuration since the transformer primary is capacitively coupled. This prevents transformer core saturation since no net dc current is allowed to flow in its primary.

Note that for the same input power, bus voltage, and duty cycle, the half-bridge requires switching transistors which have twice the current and half the voltage requirements as those of the push-pull configuration.

Full-Bridge Configuration

By replacing the bridge capacitors, C, of the half-bridge configuration of Figure 4A results. With this configuration, double the power of the half-bridge configuration can be obtained at the expense of two additional switching transistors and their associated circuitry.

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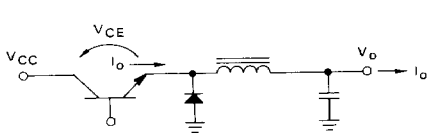
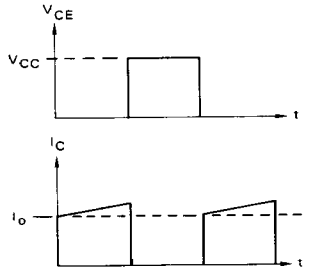
ABBREVIATIONS USED IN FIGURES 1A THROUGH 4A

I_C:	Switching transistor collector current
V_{CE}:	Switching transistor collector-to-emitter-voltage
P_{in}:	Average input power
D.C.:	Inverter duty cycle
V_{CC}:	DC bus voltage
$V_{CEO(sus)}$:	V_{CE} that transistor must withstand during turn-on
V_{CEX}:	V_{CE} that transistor must block during non-conduction period.

FIGURE 1A – SERIES CONFIGURATION





TRANSISTOR REQUIREMENTS*

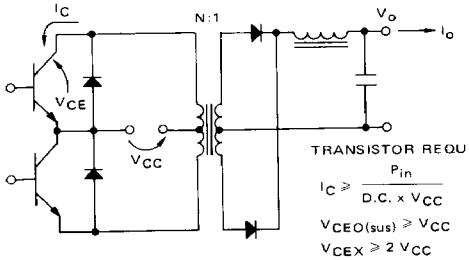
$I_C \geq I_o$

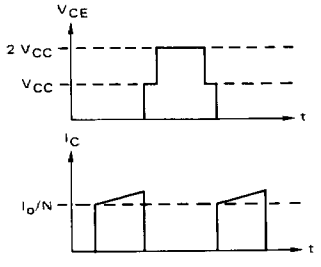
$V_{CEO(sus)} \geq V_{CC}$

$V_{CEX} \geq V_{CC}$

*See explanation of abbreviations in text.

FIGURE 2A – PUSH-PULL CONFIGURATION





TRANSISTOR REQUIREMENTS*

$I_C \geq \frac{P_{in}}{D.C. \times V_{CC}}$

$V_{CEO(sus)} \geq V_{CC}$

$V_{CEX} \geq 2\ V_{CC}$

*See explanation of abbreviations in text.

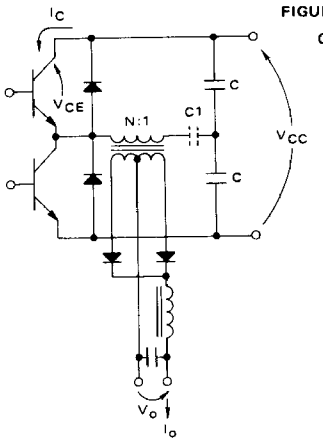
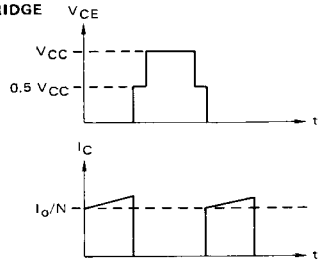


FIGURE 3A – HALF-BRIDGE CONFIGURATION



TRANSISTOR REQUIREMENTS*

$$I_C \geq \frac{2 \times P_{in}}{D.C. \times V_{CC}}$$

$V_{CEO(sus)} \geq V_{CC}/2$

$V_{CEX} \geq V_{CC}$

*See explanation of abbreviations in text.

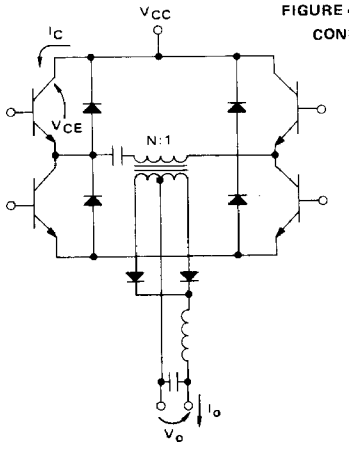
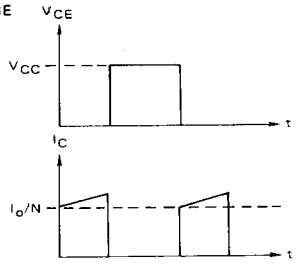


FIGURE 4A – FULL-BRIDGE CONFIGURATION



TRANSISTOR REQUIREMENTS*

$$I_C \geq \frac{P_{in}}{D.C. \times V_{CC}}$$

$V_{CEO(sus)} \geq V_{CC}$

$V_{CEX} \geq V_{CC}$

*See explanation of abbreviations in text.

REFERENCES

More detailed information on switching power supplies may be obtained by consulting the following articles:

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